

1SS355

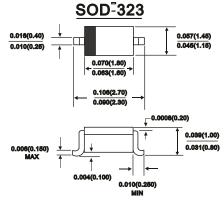
SMALL SIGNAL SWITCHING DIODES

FEATURES:

High Speed Low rever Leakage Current Small Outline Surface Mount SOD-323 Package

MECHANICAL DATA

Case : SOD-323 Plastic case Weight : Approx.0.02gram



Dimensions in inches and (millimeters)

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Rating at 25° C ambient temperature unless otherwise specified. Single phase half wave, 60 Hz resistive or inductive load. For capacitive load. derate current by 20%.

| Characterictics | Symbol | Value | | | U nit | |
|--|---------------|-------------|------------|-----|---------------------|--|
| Reverse Voltage | VR | 100 |) | | Vdc | |
| Forward Current | lF | 100 | m | | nAdc | |
| Peak Forward Surge Current | IFM(Surge) | 500 | mAdc | | nAdc | |
| Characterictics | Symbol | Max | Unit | | | |
| Total Device Dissipation FR-5 Board TA=25°C Derate Above 25°C | PD | 225 1.8 | mW mWZ° | | | |
| Thermal Resistance, Junction to Ambient | R <i>θ</i> JA | 556 | C. | | C/W | |
| Total Device Dissipation Alumina Substrate, ⁽²⁾ TA=25°C Derate Above 25°C | PD | 300 2.4 | n | | mW ₩ / °C | |
| Thermal Resistance, Junction to Ambient | R <i>θ</i> JA | 417 | | | C/W | |
| Junction and Storage Temperature | TJ, Tstg | -55 to + 12 | :5 | | °C | |
| (TA=25°C Unless Otherwise note | Symbol | Min | - | Max | Unit | |
| Reverse Breakdown Votalge (IR=100µAdc) | V(BR) | 100 | - | | Vcc | |
| Forward Voltage(IF=100mAdc) | VF | _ | 1200 | | mV dc | |
| Reverse Voltage Leakage Current (VR=80Vdc) | IR | _ | | 0.1 | µAdc | |
| Diode Capacitance (VR=0.5V, f=1.0MHz) | Ст | _ | | 3.5 | pF | |
| Revarse Recover Time (IF=IR=10mAdc) | trr | _ | | 4.0 | ns | |

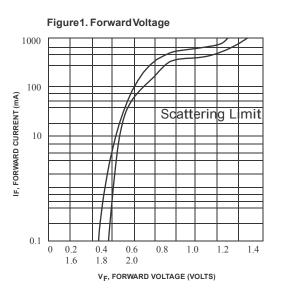
1. FR-5=1.0x0.75x0.062 in

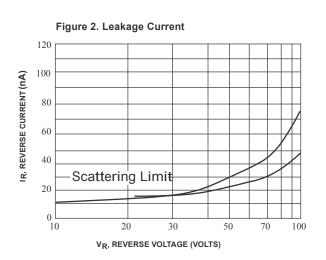
2.Alumina=0.4x0.3x0.024 in. 99.5% alumina.

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Device Marking

| Item | Marking | Eqivalent Circuitdiagram |
|---------|---------|---|
| 1SS 355 | 5D | 1 0 ─── ◀─── 0 2 |







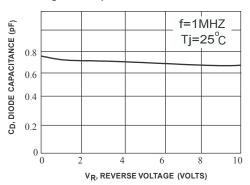
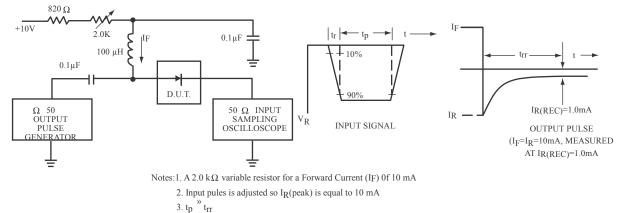


Figure 4. Recovery Time Equivalent Test Circuit







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